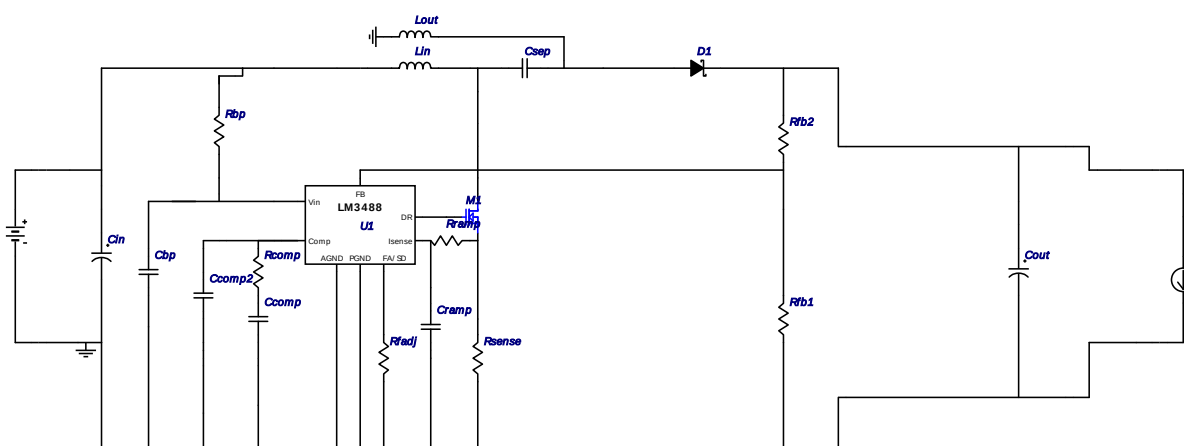
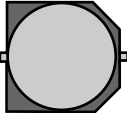




Device = LM3488MM
Topology = SEPIC
Created = 11/5/11 10:50:39 AM
BOM Cost = \$5.13
Total Pd = 2.96 W
Footprint = 1,002.0 mm2
BOM Count = 21



#	Name	Manufacturer	Part Number	Quantity	Price	Properties	Footprint
1.	Cbp	Taiyo Yuden	HMK212B7104KG-T Series= X7R	1	\$0.02	Cap= 100.0 nF ESR= 0.0 Ohm VDC= 100.0 V IRMS= 0.0 A	 0805 13mm2
2.	Ccomp	MuRata	GRM155C80G274KE01D Series= 379	1	\$0.02	Cap= 270.0 nF ESR= 0.0 Ohm VDC= 4.0 V IRMS= 0.0 A	 0402 8mm2
3.	Ccomp2	MuRata	GRM1555C1H9111JA01D Series= C0G/NP0	1	\$0.01	Cap= 910.0 pF ESR= 0.0 Ohm VDC= 50.0 V IRMS= 0.0 A	 0402 8mm2
4.	Cin	Panasonic	EEE-FK1J680UP Series= FK	2	\$0.24	Cap= 68.0 µF ESR= 350.0 mOhm VDC= 63.0 V IRMS= 400.0 mA	 SM_RADIAL_G 172mm2
5.	Cout	Kemet	T495D686K020ZTE070 Series= T495	2	\$0.59	Cap= 68.0 µF ESR= 70.0 mOhm VDC= 20.0 V IRMS= 1.317 A	 7343-31 59mm2
6.	Cramp	MuRata	GRM1885C1E112JA01D Series= C0G/NP0	1	\$0.02	Cap= 1.1 nF ESR= 0.0 Ohm VDC= 25.0 V IRMS= 0.0 A	 0603 10mm2
7.	Csep	MuRata	GRM32ER72A225KA35L Series= X7R	1	\$0.50	Cap= 2.2 µF ESR= 7.0 mOhm VDC= 100.0 V IRMS= 4.4 A	 1210 23mm2

#	Name	Manufacturer	Part Number	Quantity	Price	Properties	Footprint
8.	D1	Diodes Inc.	B2100-13-F	1	\$0.13	VF@Io= 790.0 mV VRRM= 100.0 V	 SMB 44mm2
9.	Lin	Coilcraft	XAL6060-223MEB	1	\$0.75	L= 22.0 µH DCR= 60.0 mOhm	 XAL6060 72mm2
10.	Lout	Bourns	SRR1260-121K	1	\$0.45	L= 120.0 µH DCR= 210.0 mOhm	 SRR1260 210mm2
11.	M1	Infineon Technologies	BSC340N08NS3 G	1	\$0.31	VdsMax= 80.0 V IdsMax= 23.0 Amps	 PG-TDSON-8 55mm2
12.	Rbp	Vishay-Dale	CRCW040220R0FKED Series= CRCW..e3	1	\$0.01	Res= 20.0 Ohm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
13.	Rcomp	Vishay-Dale	CRCW04021K78FKED Series= CRCW..e3	1	\$0.01	Res= 1.78 kOhm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
14.	Rfadj	Vishay-Dale	CRCW040268K1FKED Series= CRCW..e3	1	\$0.01	Res= 68.1 kOhm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
15.	Rfb1	Vishay-Dale	CRCW040210K0FKED Series= CRCW..e3	1	\$0.01	Res= 10.0 kOhm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
16.	Rfb2	Vishay-Dale	CRCW0402100KFKED Series= CRCW..e3	1	\$0.01	Res= 100.0 kOhm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
17.	Rramp	Vishay-Dale	CRCW0402100RFKED Series= CRCW..e3	1	\$0.01	Res= 100.0 Ohm Power= 63.0 mW Tolerance= 1.0%	 0402 8mm2
18.	Rsense	Susumu Co Ltd	PRL1632-R018-F-T1 Series= 237	1	\$0.21	Res= 18.0 mOhm Power= 1.0 W Tolerance= 1.0%	 1206 19mm2
19.	U1	Texas Instruments	LM3488MM	1	\$0.99	Switcher	 MUA08A 34mm2

Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	9.292 m A	Current	Input capacitor RMS ripple current
2.	Cout IRMS	1.801 A	Current	Output capacitor RMS ripple current
3.	Csep IRMS	1.807 A	Current	SEPIC capacitor RMS ripple current
4.	D1 Irms	2.056 A	Current	D1 Irms
5.	IC Ipk	4.504 m A	Current	Peak switch current in IC
6.	Iin Avg	3.351 A	Current	Average input current
7.	Iin Ipk	3.506 A	Current	Iin peak current
8.	Iin Ipp	559.916 m A	Current	Peak-to-peak input inductor ripple current
9.	Iin Irms	3.248 A	Current	Iin ripple current
10.	Iout Ipk	1.092 A	Current	Iout peak current
11.	Iout Ipp	104.714 m A	Current	Peak-to-peak output inductor ripple current
12.	Iout Irms	1.046 A	Current	Iout ripple current
13.	M1 Irms	3.769 A	Current	M1 MOSFET Irms
14.	BOM Count	21.0	General	Total Design BOM count
15.	FootPrint	1.002 k mm2	General	Total Foot Print Area of BOM components
16.	Frequency	280.0 k Hz	General	Switching frequency
17.	IC Tolerance	15.3 m V	General	IC Feedback Tolerance
18.	Mode	CCM	General	Conduction Mode
19.	Total BOM	\$5.13	General	Total BOM Cost
20.	D1 Tj	92.732 degC	Op_Point	D1 junction temperature
21.	SEPIC Resonance Freq	11.61 k Hz	Op_Point	SEPIC Resonance Frequency

#	Name	Value	Category	Description
22.	V SEPIC damping factor	105.304 m	Op_Point	V SEPIC damping factor
23.	Vin p-p	5.298 m V	Op_Point	Peak-to-peak input voltage
24.	Vsep p-p	1.252 V	Op_Point	Peak-to-peak sepic voltage
25.	Cross Freq	1.934 k Hz	Op_point	Bode plot crossover frequency
26.	Duty Cycle	77.0 %	Op_point	Duty cycle
27.	Efficiency	82.355 %	Op_point	Steady state efficiency
28.	Gain Marg	11.783 db	Op_point	Bode Plot Gain Margin
29.	IC Tj	66.032 degC	Op_point	IC junction temperature
30.	IOUT_OP	1.0 A	Op_point	Iout operating point
31.	M1 TjOP	68.859 degC	Op_point	M1 MOSFET junction temperature
32.	Phase Marg	70.184 deg	Op_point	Bode Plot Phase Margin
33.	Phase Shift	70.471 deg	Op_point	Bode Plot Phase Shift
34.	VIN_OP	5.0 V	Op_point	Vin operating point
35.	Vout p-p	161.53 m V	Op_point	Peak-to-peak output ripple voltage
36.	Cin Pd	15.108 μ W	Power	Input capacitor power dissipation
37.	Cout Pd	113.467 m W	Power	Output capacitor power dissipation
38.	Csep Pd	22.845 m W	Power	SEPIC capacitor power dissipation
39.	D1 Pd	794.075 m W	Power	Diode power dissipation
40.	D1 PdCond	790.0 m W	Power	Diode conduction losses
41.	D1 PdSw	4.075 m W	Power	Diode switching losses
42.	IC Pd	180.16 m W	Power	IC power dissipation
43.	Lin Pd	634.597 m W	Power	Lin power dissipation
44.	Lout Pd	229.748 m W	Power	Lout power dissipation
45.	M1 Pd	778.215 m W	Power	M1 MOSFET total power dissipation
46.	M1 PdCond	548.065 m W	Power	M1 MOSFET conduction losses
47.	M1 PdSw	230.15 m W	Power	M1 MOSFET switching losses
48.	Rsense Pd	255.647 m W	Power	LED Current Rsns Power Dissipation
49.	Total Pd	2.957 W	Power	Total Power Dissipation

Design Inputs

#	Name	Value	Description
1.	Iout	1.0 A	Maximum Output Current
2.	Iout1	1.0 Amps	Output Current #1
3.	VinMax	40.0 V	Maximum input voltage
4.	VinMin	5.0 V	Minimum input voltage
5.	Vout	13.8 V	Output Voltage
6.	Vout1	13.8 Volt	Output Voltage #1
7.	base_pn	LM3488	National Based Product Number
8.	Ta	30.0 degC	Ambient temperature

Design Assistance

1. **LM3488** Product Folder : <http://www.national.com/pf/LM/LM3488.html> : contains the data sheet and other resources.

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You should completely validate and test your design implementation to confirm the system functionality for your application prior to production.

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